Data sheet

6ES7511-1CK01-0AB0



SIMATIC S7-1500 Compact CPU CPU 1511C-1PN, central processing unit with working memory 175 KB for program and 1 MB for data, 16 digital inputs, 16 digital outputs, 5 analog inputs, 2 analog outputs, 6 high speed counters, 4 high speed outputs for PTO/PWM/frequency output 1. interface: PROFINET IRT with 2 port switch, 60 NS bit-performance, incl. front connector push-in, SIMATIC memory card necessary

General information	
Product type designation	CPU 1511C-1 PN
HW functional status	FS03
Firmware version	V2.9
Product function	
● I&M data	Yes; I&M0 to I&M3
 Isochronous mode 	Yes; With minimum OB 6x cycle of 625 µs (distributed)
Engineering with	
STEP 7 TIA Portal configurable/integrated from version	V17 (FW V2.9) / V15 (FW V2.5) or higher; with older TIA Portal versions configurable as 6ES7511-1CK00-0AB0
Configuration control	
via dataset	Yes
Display	
Screen diagonal [cm]	3.45 cm
Control elements	
Number of keys	8
Mode buttons	2
Supply voltage	
Rated value (DC)	24 V
permissible range, lower limit (DC)	19.2 V; 20.4 V DC, for supplying the digital inputs/outputs
permissible range, upper limit (DC)	28.8 V
Reverse polarity protection	Yes
Mains buffering	
 Mains/voltage failure stored energy time 	5 ms; Refers to the power supply on the CPU section
Repeat rate, min.	1/s
Input current	
Current consumption (rated value)	0.8 A; Without load; 9.8 A: CPU + load
Current consumption, max.	1 A; Without load; 10 A: CPU + load
Inrush current, max.	1.9 A; Rated value
l²t	0.34 A²·s
Digital inputs	
 from load voltage L+ (without load), max. 	20 mA; per group
Digital outputs	
• from load voltage L+, max.	30 mA; Per group, without load
output voltage / header	
Rated value (DC)	24 V
Encoder supply	
Number of outputs	1; One common 24 V encoder supply
24 V encoder supply	
• 24 V	Yes; L+ (-0.8 V)

Short-circuit protection	Yes
Output current, max.	1 A
Power	
Infeed power to the backplane bus	10 W
Power consumption from the backplane bus (balanced)	8.5 W
Power loss	
Power loss, typ.	11.8 W
Memory	
Number of slots for SIMATIC memory card	1
SIMATIC memory card required	Yes
Work memory	
integrated (for program)	175 kbyte
integrated (for data)	1 Mbyte
Load memory	
Plug-in (SIMATIC Memory Card), max.	32 Gbyte
Backup	
maintenance-free	Yes
CPU processing times	
for bit operations, typ.	60 ns
for word operations, typ.	72 ns
for fixed point arithmetic, typ.	96 ns
for floating point arithmetic, typ.	384 ns
CPU-blocks	
Number of elements (total)	4 000; Blocks (OB, FB, FC, DB) and UDTs
DB	
Number range	1 60 999; subdivided into: number range that can be used by the user: 1
a Ciza may	59 999, and number range of DBs created via SFC 86: 60 000 60 999
• Size, max.	1 Mbyte; For DBs with absolute addressing, the max. size is 64 KB
	0 65 535
Number range Size may	
• Size, max.	175 kbyte
Number range	0 65 535
• Size, max.	175 kbyte
OB	170 kbyte
• Size, max.	175 kbyte
Number of free cycle OBs	100
Number of time alarm OBs	20
Number of delay alarm OBs	20
Number of cyclic interrupt OBs	20; With minimum OB 3x cycle of 500 μs
Number of process alarm OBs	50
Number of DPV1 alarm OBs	3
Number of isochronous mode OBs	1
Number of technology synchronous alarm OBs	2
Number of startup OBs	100
Number of asynchronous error OBs	4
Number of synchronous error OBs	2
Number of diagnostic alarm OBs	1
Nesting depth	
per priority class	24
Counters, timers and their retentivity	
S7 counter	
Number	2 048
Retentivity	
— adjustable	Yes
IEC counter	
Number	Any (only limited by the main memory)
- 11911119791	, (e.i., illiniated by the main monthly)
Retentivity	
Retentivity — adjustable	Yes
— adjustable	Yes
·	Yes 2 048

Potentivity	
Retentivity — adjustable	Yes
— adjustable IEC timer	Tes
Number	Any (only limited by the main memory)
Retentivity	Any (only limited by the main memory)
— adjustable	Yes
Data areas and their retentivity	res
	400 khuta. In tatak ayailahla yatantiya mamany fay hit mamaniga timaya
Retentive data area (incl. timers, counters, flags), max.	128 kbyte; In total; available retentive memory for bit memories, timers, counters, DBs, and technology data (axes): 88 KB
Extended retentive data area (incl. timers, counters, flags), max.	1 Mbyte; When using PS 6 0W 24/48/60 V DC HF
Flag	
• Size, max.	16 kbyte
Number of clock memories	8; 8 clock memory bit, grouped into one clock memory byte
Data blocks	
Retentivity adjustable	Yes
Retentivity preset	No
Local data	
per priority class, max.	64 kbyte; max. 16 KB per block
Address area	
Number of IO modules	1 024; max. number of modules / submodules
I/O address area	
• Inputs	32 kbyte; All inputs are in the process image
• Outputs	32 kbyte; All outputs are in the process image
per integrated IO subsystem	
— Inputs (volume)	8 kbyte
— Outputs (volume)	8 kbyte
per CM/CP	,
— Inputs (volume)	8 kbyte
— Outputs (volume)	8 kbyte
Subprocess images	,
Number of subprocess images, max.	32
Hardware configuration Number of distributed IO systems	32; A distributed I/O system is characterized not only by the integration of distributed I/O via PROFINET or PROFIBUS communication modules, but also
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Digital inputs, parameterizable	Yes
Source/sink input	P-reading
Input characteristic curve in accordance with IEC 61131, type 3	Yes
Digital input functions, parameterizable	
Gate start/stop	Yes
Capture	Yes
Synchronization	Yes
Input voltage	103
Type of input voltage	DC
Rated value (DC)	24 V
• for signal "0"	-3 to +5V
• for signal "1"	+11 to +30V
Input current	111 10 1000
• for signal "1", typ.	2.5 mA
Input delay (for rated value of input voltage)	2.5 IIIA
for standard inputs	
	Yes; none / 0.05 / 0.1 / 0.4 / 1.6 / 3.2 / 12.8 / 20 ms
— parameterizable	
— at "0" to "1", min. — at "0" to "1", max.	4 μs; for parameterization "none" 20 ms
— at "1" to "0", min.	4 μs; for parameterization "none" 20 ms
— at "1" to "0", max.	20 IIIS
for interrupt inputs	Voc: Came as for standard insuits
— parameterizable	Yes; Same as for standard inputs
for technological functions	Vac Carra as far standard in the
— parameterizable	Yes; Same as for standard inputs
Cable length	4 000 mg COO mg far ta alama la miral famation and display and in a mark familiar and
• shielded, max.	1 000 m; 600 m for technological functions; depending on input frequency, encoder and cable quality; max. 50 m at 100 kHz
 unshielded, max. 	600 m; for technological functions: No
Digital outputs	, , , , , , , , , , , , , , , , , , , ,
Type of digital output	Transistor
integrated channels (DO)	16
Current-sourcing	Yes; Push-pull output
Short-circuit protection	Yes; electronic/thermal
Response threshold, typ.	1.6 A with standard output, 0.5 A with high-speed output; see manual for details
Limitation of inductive shutdown voltage to	-0.8 V
Controlling a digital input	Yes
Accuracy of pulse duration	Up to ±100 ppm ±2 µs at high-speed output; see manual for details
minimum pulse duration	2 µs; With High Speed output
Digital output functions, parameterizable	hay a character
Switching tripped by comparison values	Yes; As output signal of a high-speed counter
PWM output	Yes
— Number, max.	4
Cycle duration, parameterizable	Yes
— ON period, min.	0 %
— ON period, max.	100 %
Resolution of the duty cycle	0.0036 %; For S7 analog format, min. 40 ns
Frequency output	Yes
Switching capacity of the outputs	
with resistive load, max.	0.5 A; 0.1 A with high-speed output, i.e. when using a high-speed output; see
	manual for details
• on lamp load, max.	5 W; 1 W with high-speed output, i.e. when using a high-speed output; see
	manual for details
Load resistance range	
• lower limit	48 Ω ; 240 ohms with high-speed output, i.e. when using a high-speed output; see manual for details
• upper limit	12 kΩ
Output voltage	
 Type of output voltage 	DC
• for signal "0", max.	1 V; With high-speed output, i.e. when using a high-speed output; see manual for details
for signal "0", max.for signal "1", min.	

Output current	
• for signal "1" rated value	0.5 A; 0.1 A with high-speed output, i.e. when using a high-speed output,
	observe derating; see manual for details
• for signal "1" permissible range, min.	2 mA
• for signal "1" permissible range, max.	0.6 A; 0.12 A with high-speed output, i.e. when using a high-speed output, observe derating; see manual for details
• for signal "0" residual current, max.	0.5 mA
Output delay with resistive load	
• "0" to "1", max.	200 μs
• "1" to "0", max.	500 µs; Load-dependent
for technological functions	
— "0" to "1", max.	5 µs; Depending on the output used, see additional description in manual
— "1" to "0", max.	5 μs; Depending on the output used, see additional description in manual
Parallel switching of two outputs	
for logic links	Yes; for technological functions: No
• for uprating	No
for redundant control of a load	Yes; for technological functions: No
Switching frequency	
with resistive load, max.	100 kHz; For high-speed output, 100 Hz for standard output
with inductive load, max.	0.5 Hz; Acc. to IEC 60947-5-1, DC-13; observe derating curve
• on lamp load, max.	10 Hz
Total current of the outputs	
Current per channel, max.	0.5 A; see additional description in the manual
Current per group, max.	8 A; see additional description in the manual
Current per power supply, max.	4 A; 2 power supplies for each group, current per power supply max. 4 A, see additional description in manual
for technological functions	
— Current per channel, max.	0.5 A; see additional description in the manual
Relay outputs	
Number of relay outputs	0
Cable length	
• shielded, max.	1 000 m; 600 m for technological functions; depending on output frequency, load, and cable quality; max. 50 m at 100 kHz
unshielded, max.	600 m; for technological functions: No
Analog inputs	
Number of analog inputs	5; 4x for U/I, 1x for R/RTD
 For current measurement 	4; max.
 For voltage measurement 	4; max.
 For resistance/resistance thermometer measurement 	1
permissible input voltage for voltage input (destruction limit), max.	28.8 V
permissible input current for current input (destruction limit), max.	40 mA
Cycle time (all channels), min.	1 ms; Dependent on the parameterized interference frequency suppression; for details, see conversion procedure in manual
Technical unit for temperature measurement adjustable	Yes; °C/°F/K
Input ranges (rated values), voltages	
• 0 to +10 V	Yes; Physical measuring range: ± 10 V
— Input resistance (0 to 10 V)	100 kΩ
• 1 V to 5 V	Yes; Physical measuring range: ± 10 V
— Input resistance (1 V to 5 V)	100 kΩ
• -10 V to +10 V	Yes
— Input resistance (-10 V to +10 V)	100 kΩ
• -5 V to +5 V	Yes; Physical measuring range: ± 10 V
— Input resistance (-5 V to +5 V)	100 kΩ
Input ranges (rated values), currents	
• 0 to 20 mA	Yes; Physical measuring range: ± 20 mA
— Input resistance (0 to 20 mA)	50 Ω; Plus approx. 55 ohm for overvoltage protection by PTC
• -20 mA to +20 mA	Yes
— Input resistance (-20 mA to +20 mA)	50 Ω; Plus approx. 55 ohm for overvoltage protection by PTC
• 4 mA to 20 mA	Yes; Physical measuring range: ± 20 mA
— Input resistance (4 mA to 20 mA)	50 Ω; Plus approx. 55 ohm for overvoltage protection by PTC
	,

• Ni 100	Yes; Standard/climate
— Input resistance (Ni 100)	10 ΜΩ
• Pt 100	Yes; Standard/climate
— Input resistance (Pt 100)	10 ΜΩ
Input ranges (rated values), resistors	10 Maz
• 0 to 150 ohms	Yes; Physical measuring range: 0 600 ohms
— Input resistance (0 to 150 ohms)	10 ΜΩ
• 0 to 300 ohms	Yes; Physical measuring range: 0 600 ohms
— Input resistance (0 to 300 ohms)	10 ΜΩ
• 0 to 600 ohms	Yes
— Input resistance (0 to 600 ohms)	10 ΜΩ
Cable length	
shielded, max.	800 m; for U/I, 200 m for R/RTD
Analog outputs	••• •• •• •• •• •• •• •• •• •• •• •• ••
integrated channels (AO)	2
Voltage output, short-circuit protection	Yes
Cycle time (all channels), min.	1 ms; Dependent on the parameterized interference frequency suppression; for
Cycle time (all chamicis), min.	details, see conversion procedure in manual
Output ranges, voltage	
• 0 to 10 V	Yes
• 1 V to 5 V	Yes
• -10 V to +10 V	Yes
Output ranges, current	
• 0 to 20 mA	Yes
• -20 mA to +20 mA	Yes
• 4 mA to 20 mA	Yes
Load impedance (in rated range of output)	
with voltage outputs, min.	1 kΩ
 with voltage outputs, capacitive load, max. 	100 nF
 with current outputs, max. 	500 Ω
 with current outputs, inductive load, max. 	1 mH
Cable length	
shielded, max.	200 m
Analog value generation for the inputs	
Integration and conversion time/resolution per channel	
Resolution with overrange (bit including sign), max.	16 bit
 Integration time, parameterizable 	Yes; 2.5 / 16.67 / 20 / 100 ms, acts on all channels
 Interference voltage suppression for interference 	400 / 60 / 50 / 10
frequency f1 in Hz	
Smoothing of measured values	
parameterizable	Yes
• Step: None	Yes
• Step: low	Yes
Step: Medium	Yes
Step: High	Yes
Analog value generation for the outputs	
Integration and conversion time/resolution per channel	
Resolution with overrange (bit including sign), max.	16 bit
Settling time	
 for resistive load 	1.5 ms
for capacitive load	2.5 ms
for inductive load	2.5 ms
Encoder	
Connection of signal encoders	
 for voltage measurement 	Yes
 for current measurement as 4-wire transducer 	Yes
 for resistance measurement with two-wire connection 	Yes
• for resistance measurement with three-wire connection	Yes
for resistance measurement with four-wire connection	Yes
Connectable encoders	
• 2-wire sensor	Yes

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— permissible quiescent current (2-wire sensor), max.	1.5 mA
Encoder signals, incremental encoder (asymmetrical)	
Input voltage	24 V
 Input frequency, max. 	100 kHz
 Counting frequency, max. 	400 kHz; with quadruple evaluation
Signal filter, parameterizable	Yes
 Incremental encoder with A/B tracks, 90° phase offset 	Yes
 Incremental encoder with A/B tracks, 90° phase offset and zero track 	Yes
• pulse encoder	Yes
 pulse encoder with direction 	Yes
 pulse encoder with one impulse signal per count direction 	Yes
Errors/accuracies	
Linearity error (relative to input range), (+/-)	0.1 %
Temperature error (relative to input range), (+/-)	0.005 %/K
Crosstalk between the inputs, max.	-60 dB
Repeat accuracy in steady state at 25 °C (relative to input range), (+/-)	0.05 %
Output ripple (relative to output range, bandwidth 0 to 50 kHz), (+/-)	0.02 %
Linearity error (relative to output range), (+/-)	0.15 %
Temperature error (relative to output range), (+/-)	0.005 %/K
Crosstalk between the outputs, max.	-80 dB
Repeat accuracy in steady state at 25 °C (relative to output range), (+/-)	0.05 %
Operational error limit in overall temperature range	
Voltage, relative to input range, (+/-)	0.3 %
Current, relative to input range, (+/-)	0.3 %
 Resistance, relative to input range, (+/-) 	0.3 %
• Resistance thermometer, relative to input range, (+/-)	Pt100 Standard: ±2 K, Pt100 Climate: ±1 K, Ni100 Standard: ±1.2 K, Ni100 Climate: ±1 K
Voltage, relative to output range, (+/-)	0.3 %
Current, relative to output range, (+/-)	0.3 %
Basic error limit (operational limit at 25 °C)	
 Voltage, relative to input range, (+/-) 	0.2 %
 Current, relative to input range, (+/-) 	0.2 %
 Resistance, relative to input range, (+/-) 	0.2 %
 Resistance thermometer, relative to input range, (+/-) 	Pt100 Standard: ±1 K, Pt100 Climate: ±0.5 K, Ni100 Standard: ±0.6 K, Ni100 Climate: ±0.5 K
 Voltage, relative to output range, (+/-) 	0.2 %
 Current, relative to output range, (+/-) 	0.2 %
Interference voltage suppression for f = n x (f1 +/- 1 %), f1 = interfe	rence frequency
 Series mode interference (peak value of interference < rated value of input range), min. 	30 dB
Common mode voltage, max.	10 V
Common mode interference, min.	60 dB; at 400 Hz: 50 dB
Interfaces	
Number of PROFINET interfaces	1
1. Interface	
Interface types	
• RJ 45 (Ethernet)	Yes; X1
Number of ports	2
integrated switch	Yes
Integrated switch Protocols	160
	Voc. IDv4
IP protocol PROFINITIO Controller	Yes; IPv4
PROFINET IO Controller	Yes
PROFINET IO Device	Yes
SIMATIC communication	Yes
Open IE communication	Yes; Optionally also encrypted
Web server	Yes
Media redundancy	Yes
PROFINET IO Controller	
Services	

	Vac
	Yes
	Yes
•	Yes; Requirement: IRT and isochronous mode (MRPD optional)
	Yes
	Yes; per user program
·	Yes; Max. 32 PROFINET devices
Number of connectable IO Devices, max.	128; In total, up to 256 distributed I/O devices can be connected via AS-i, PROFIBUS or PROFINET
— Of which IO devices with IRT, max.	64
 Number of connectable IO Devices for RT, max. 	128
	128
 Number of IO Devices that can be simultaneously activated/deactivated, max. 	8; in total across all interfaces
 Number of IO Devices per tool, max. 	8
	The minimum value of the update time also depends on communication share set for PROFINET IO, on the number of IO devices, and on the quantity of configured user data
Update time for IRT	
	250 µs to 4 ms; Note: In the case of IRT with isochronous mode, the minimum update time of 625 µs of the isochronous OB is decisive
	500 µs to 8 ms; Note: In the case of IRT with isochronous mode, the minimum update time of 625 µs of the isochronous OB is decisive
	1 ms to 16 ms
•	2 ms to 32 ms
·	4 ms to 64 ms
•	Update time = set "odd" send clock (any multiple of 125 μs: 375 μs, 625 μs 3
	875 µs)
Update time for RT	
·	250 μs to 128 ms
— for send cycle of 500 μs	500 μs to 256 ms
— for send cycle of 1 ms	1 ms to 512 ms
— for send cycle of 2 ms	2 ms to 512 ms
— for send cycle of 4 ms	4 ms to 512 ms
PROFINET IO Device	
Services	
	Yes
	No
	Yes
••	Yes; per user program
	Yes
Number of IO Controllers with shared device, max.	4
— activation/deactivation of I-devices	Yes; per user program
— Asset management record	Yes; per user program
Interface types	
RJ 45 (Ethernet)	
• 100 Mbps	Yes
Autonegotiation	Yes
Autocrossing	Yes
Industrial Ethernet status LED	Yes
Protocols	
Number of connections	
Number of connections, max.	96; via integrated interfaces of the CPU and connected CPs / CMs
 Number of connections reserved for ES/HMI/web 	10
Number of connections via integrated interfaces	64
Number of S7 routing paths	16
Redundancy mode	
H-Sync forwarding	Yes
Media redundancy	
— Media redundancy	only via 1st interface (X1)
	Vac. MDD Automorphism to IEC 62420 2 Edition 2.0 MDD Managery
	Yes; MRP Automanager according to IEC 62439-2 Edition 2.0, MRP Manager; MRP Client

 Switchover time on line break, typ. 	200 ms; For MRP, bumpless for MRPD
Number of stations in the ring, max.	50
SIMATIC communication	
 PG/OP communication 	Yes; encryption with TLS V1.3 pre-selected
 S7 routing 	Yes
 S7 communication, as server 	Yes
 S7 communication, as client 	Yes
User data per job, max.	See online help (S7 communication, user data size)
Open IE communication	
• TCP/IP	Yes
— Data length, max.	64 kbyte
 several passive connections per port, supported 	Yes
• ISO-on-TCP (RFC1006)	Yes
— Data length, max.	64 kbyte
• UDP	Yes
— Data length, max.	2 kbyte; 1 472 bytes for UDP broadcast
— UDP multicast	Yes; Max. 5 multicast circuits
• DHCP	Yes
• DNS	Yes
• SNMP	Yes
• DCP	Yes
• LLDP	Yes
Encryption	Yes; Optional
Web server	
• HTTP	Yes; Standard and user pages
• HTTPS	Yes; Standard and user pages
OPC UA	
Runtime license required	Yes; "Small" license required
OPC UA Client	Yes
Application authentication	Yes
— Security policies	Available security policies: None, Basic128Rsa15, Basic256Rsa15, Basic256Sha256
User authentication	"anonymous" or by user name & password
Number of connections, max.	4
Number of nodes of the client interfaces, recommended max.	1 000
 Number of elements for one call of OPC_UA_NodeGetHandleList/OPC_UA_ReadList/OPC_I max. 	300
Number of elements for one call of OPC UA NameSpaceGetIndexList, max.	20
Number of elements for one call of OPC_UA_MethodGetHandleList, max.	100
 Number of simultaneous calls of the client instructions for session management, per connection, 	1
max.— Number of simultaneous calls of the client instructions for data access, per connection, max.	5
Number of registerable nodes, max.	5 000
Number of registerable method calls of OPC_UA_MethodCall, max.	100
 Number of inputs/outputs when calling OPC_UA_MethodCall, max. 	20
OPC UA Server	Yes; Data access (read, write, subscribe), method call, custom address space
 Application authentication 	Yes
— Security policies	Available security policies: None, Basic128Rsa15, Basic256Rsa15, Basic256Sha256
 User authentication 	"anonymous" or by user name & password
 — GDS support (certificate management) 	Yes
Number of sessions, max.	32
 Number of accessible variables, max. 	50 000
 Number of registerable nodes, max. 	10 000
 Number of subscriptions per session, max. 	20
— Sampling interval, min.	100 ms

— Publishing interval, min.	500 ms
Number of server methods, max.	20
 Number of inputs/outputs per server method, max. 	20
 Number of monitored items, recommended max. 	1 000; for 1 s sampling interval and 1 s send interval
 Number of server interfaces, max. 	10 of each "Server interfaces" / "Companion specification" type and 20 of the type "Reference namespace"
 Number of nodes for user-defined server interfaces, max. 	1 000
 Alarms and Conditions 	Yes
 Number of program alarms 	100
 Number of alarms for system diagnostics 	50
Further protocols	
• MODBUS	Yes; MODBUS TCP
Isochronous mode	
Equidistance	Yes
S7 message functions	
Number of login stations for message functions, max.	32
Program alarms	Yes
Number of configurable program messages, max.	5 000; Program messages are generated by the "Program Alarm" block,
	ProDiag or GRAPH
Number of loadable program messages in RUN, max.	2 500
Number of simultaneously active program alarms	
Number of program alarms	600
Number of alarms for system diagnostics	100
Number of alarms for motion technology objects	80
Test commissioning functions	
Joint commission (Team Engineering)	Yes; Parallel online access possible for up to 5 engineering systems
Status block	Yes; Up to 8 simultaneously (in total across all ES clients)
Single step	No
Number of breakpoints	8
Status/control	
 Status/control variable 	Yes
 Variables 	Inputs/outputs, memory bits, DBs, distributed I/Os, timers, counters
 Number of variables, max. 	
of which status variables, max.	200; per job
of which control variables, max.	200; per job
Forcing	
Forcing	Yes
Forcing, variables	Peripheral inputs/outputs
Number of variables, max.	200
Diagnostic buffer	
• present	Yes
Number of entries, max.	1 000
— of which powerfail-proof	500
Traces	
Number of configurable Traces	4; Up to 512 KB of data per trace are possible
Interrupts/diagnostics/status information	T, OP to 012 No or data per trace are possible
Alarms	
	Vee
Diagnostic alarm	Yes
Diagnostic alarm Hardware interrupt	Yes Yes
Diagnostic alarmHardware interruptDiagnoses	Yes
 Diagnostic alarm Hardware interrupt Diagnoses Monitoring the supply voltage 	Yes Yes
 Diagnostic alarm Hardware interrupt Diagnoses Monitoring the supply voltage Wire-break 	Yes Yes; for analog inputs/outputs, see description in manual
 Diagnostic alarm Hardware interrupt Diagnoses Monitoring the supply voltage 	Yes Yes
 Diagnostic alarm Hardware interrupt Diagnoses Monitoring the supply voltage Wire-break 	Yes Yes; for analog inputs/outputs, see description in manual
 Diagnostic alarm Hardware interrupt Diagnoses Monitoring the supply voltage Wire-break Short-circuit 	Yes Yes Yes; for analog inputs/outputs, see description in manual Yes; for analog outputs, see description in manual
 Diagnostic alarm Hardware interrupt Diagnoses Monitoring the supply voltage Wire-break Short-circuit A/B transition error at incremental encoder 	Yes Yes Yes; for analog inputs/outputs, see description in manual Yes; for analog outputs, see description in manual
Diagnostic alarm Hardware interrupt Diagnoses Monitoring the supply voltage Wire-break Short-circuit A/B transition error at incremental encoder Diagnostics indication LED	Yes Yes; for analog inputs/outputs, see description in manual Yes; for analog outputs, see description in manual Yes
Diagnostic alarm Hardware interrupt Diagnoses Monitoring the supply voltage Wire-break Short-circuit A/B transition error at incremental encoder Diagnostics indication LED RUN/STOP LED	Yes Yes; for analog inputs/outputs, see description in manual Yes; for analog outputs, see description in manual Yes Yes
Diagnostic alarm Hardware interrupt Diagnoses Monitoring the supply voltage Wire-break Short-circuit A/B transition error at incremental encoder Diagnostics indication LED RUN/STOP LED ERROR LED	Yes Yes Yes; for analog inputs/outputs, see description in manual Yes; for analog outputs, see description in manual Yes Yes
Diagnostic alarm Hardware interrupt Diagnoses Monitoring the supply voltage Wire-break Short-circuit A/B transition error at incremental encoder Diagnostics indication LED RUN/STOP LED ERROR LED MAINT LED	Yes Yes; for analog inputs/outputs, see description in manual Yes; for analog outputs, see description in manual Yes Yes Yes Yes Yes

Channel status display	Yes
 for channel diagnostics 	Yes; For analog inputs/outputs
Connection display LINK TX/RX	Yes
Supported technology objects	
Motion Control	Yes; Note: The number of technology objects affects the cycle time of the PLC program; selection guide via the TIA Selection Tool
 Number of available Motion Control resources for technology objects 	800
 Required Motion Control resources 	
 per speed-controlled axis 	40
 per positioning axis 	80
— per synchronous axis	160
— per external encoder	80
— per output cam	20
— per cam track	160
— per probe	40
 Positioning axis 	
 Number of positioning axes at motion control cycle of 4 ms (typical value) 	5
 Number of positioning axes at motion control cycle of 8 ms (typical value) 	10
Controller	
PID_Compact	Yes; Universal PID controller with integrated optimization
PID_3Step	Yes; PID controller with integrated optimization for valves
PID-Temp	Yes; PID controller with integrated optimization for temperature
Counting and measuring	
High-speed counter	Yes
Integrated Functions	
Counting functions	
Continuous counting	Yes
Counter response parameterizable	Yes
Hardware gate via digital input	Yes
Software gate	Yes
Event-controlled stop	Yes
Synchronization via digital input	Yes
Counting range, parameterizable	Yes
Comparator — Number of comparators	2; per count channel; see manual for details
Number of comparators Direction dependency	Yes
— Can be changed from user program	Yes
Position detection	165
Incremental acquisition	Yes
Suitable for S7-1500 Motion Control	Yes
Measuring functions	160
Measuring time, parameterizable	Yes
Dynamic measurement period adjustment	Yes
Number of thresholds, parameterizable	2
Measuring range	
Frequency measurement, min.	0.04 Hz
Frequency measurement, max.	400 kHz; with quadruple evaluation
Cycle duration measurement, min.	2.5 µs
Cycle duration measurement, max.	25 s
Accuracy	
Frequency measurement	100 ppm; depending on measuring interval and signal evaluation
Cycle duration measurement	100 ppm; depending on measuring interval and signal evaluation
Velocity measurement	100 ppm; depending on measuring interval and signal evaluation
Potential separation	The first of the control of the cont
Potential separation Potential separation digital inputs	
between the channels	No
between the channels, in groups of	16
Potential separation digital outputs	
between the channels	No
- DOMOGIT THE GRAPHICIE	

• between the channels, in groups of Potential separation channels • between the channels and backplane bus • between the channels and load voltage L+ Isolation Isolation tested with Ambient conditions Ambient conditions • horizontal installation, min. • horizontal installation, min. • horizontal installation, min. • vertical installation, max. • vertical installation, max. • vertical installation, max • vertical installation amax • vertical		
Between the channels and backplane bus Between the channels and load voltage L+ No Isolation Isolation tested with Ambient conditions Ambient conditions Ambient conditions Anbient temperature during operation • horizontal installation, min. • horizontal installation, min. • horizontal installation, min. • vertical installation in relating to sea level • Installation altitude above sea level, max. 70 °C Altitude during operation relating to sea level • Installation altitude above sea level, max. 5 000 m; Restrictions for installation altitudes > 2 000 m; see manual configuration / programming / header Programming language — LAD Ves — FBD — STL — SCL — GRAPH Yes Know-how protection • User program protection/password protection • Ves • Copy protection • User program protection/password protection • Ves • Block protection • protection level: Write protection • Protection level: Write protection • Protection level: Write protection • Protection level: Candlwrite protection • Protection level: Complete protection • P	between the channels, in groups of	16
Between the channels and load voltage L+ Solation Solation tested with Ambient conditions Ambient temperature during operation • horizontal installation, min. • horizontal installation, max. • vertical installation, min. • vertical installation, min. • vertical installation, min. • vertical installation, max. • vertical installation, min. • vertical installation, max. • vertical installation, min. • vertical installation	Potential separation channels	
Isolation Isolation tested with Ambient conditions Ambient conditions Ambient conditions Ambient temperature during operation • horizontal installation, min. • horizontal installation, min. • horizontal installation, min. • horizontal installation, min. • vertical installation, min. • vertical installation, max. • vertical installation, max. 40 °C; note derating data for onboard I/O in the manual. Display: 50 °C, at an operating temperature of typically 50 °C, the display is switched off • with temperature during storage/transportation • min. • max. And °C; note derating data for onboard I/O in the manual. Display: 40 °C, at an operating temperature of typically 40 °C, the display is switched off Ambient temperature during storage/transportation • min. • max. 70 °C Altitude during operation relating to sea level • installation altitude above sea level, max. configuration / programming / header Programming language — LAD — FBD — Yes — STL — SCL — GRAPH — Yes	 between the channels and backplane bus 	Yes
Isolation tested with Ambient conditions Ambient temperature during operation • horizontal installation, min. • horizontal installation, max. • vertical installation instituted i	Between the channels and load voltage L+	No
Ambient conditions Ambient prograture during operation • horizontal installation, min. • horizontal installation, max. • vertical installation, min. • vertical installation, max. 40 °C; note derating data for onboard I/O in the manual. Display: 50 °C, dt an operating temperature of typically 50 °C, the display is switched off Ambient temperature during storage/transportation • min. • max. All the during operation relating to sea level • Installation altitude above sea level, max. Configuration / header Programming language — LAD — FBD — STI. — SCI. — SCI. — SCI. — SCI. — SCI. — Yes — STI. — Yes — STI. — Yes Know-how protection • User program protection/password protection • User program protection/password protection • User program protection/password protection • User program protection (Pesses protection) • Protection level: Write protection • Protection level: Read/write protection • Protection level: Complete protecti	Isolation	
Ambient temperature during operation • horizontal installation, min. • horizontal installation, min. • horizontal installation, min. • horizontal installation, max. • horizontal installation, min. • vertical installation, min. • vertical installation, min. • vertical installation, min. • vertical installation, max. • vertical installation, max. • vertical installation, max. • vertical installation, max. • vertical installation, max. • vertical installation, max. • vertical installation, max. • vertical installation, max. • vertical installation, max. • vertical installation, min. • vertical installation, max. • vertical installation, min. • vertical installation, min. • vertical installation, min. • vertical installation	Isolation tested with	707 V DC (type test)
horizontal installation, min. horizontal installation, max. horizontal installation, max. horizontal installation, max. horizontal installation, max. horizontal installation, min. vertical installation, min. vertical installation, min. vertical installation, max. 40 °C; note derating data for onboard I/O in the manual. Display: 40 °C, at an operating temperature of typically 40 °C, the display is switched off Ambient temperature during storage/transportation min. 40 °C max. 70 °C Altitude during operation relating to sea level installation altitude above sea level, max. 5000 m; Restrictions for installation altitudes > 2 000 m, see manual configuration / programming / header Programming language LAD Yes STL SCL Yes SCL GRAPH Yes Know-how protection User program protection/password protection Ves Copy protection Slock protection Protection of confidential configuration data Password for display Protection level: Write protection Protection level: Read/write protection Protection level: Complete protection Protection level: Complete protection Protection level: Complete protection Protection level: Complete protection Yes Dimensions Width Height Depth Wolghts	Ambient conditions	
horizontal installation, max. vertical installation, min. vertical installation, max. 40 °C; note derating data for onboard I/O in the manual. Display: 40 °C, at an operating temperature of typically 40 °C, the display is switched off Ambient temperature during storage/transportation min. vertical installation altitude above sea level. Installation altitude above sea level, max. configuration / header configuration / header Programming language — LAD Yes — STL — SCL — SCL — GRAPH Yes Know-how protection • User program protection/password protection • User program protection/password protection • Diservoir for display • Protection level: Write protection • protection level: Write protection • Protection level: Read/write protection • Protection level: Complete protection • Protection level: Protection •	Ambient temperature during operation	
vertical installation, min. vertical installation, min. vertical installation, max. vertical installation, max. 40 °C; note derating data for onboard I/O in the manual. Display: 40 °C, at an operating temperature of typically 40 °C, the display is switched off Ambient temperature during storage/transportation min. vertical installation relating to sea level enax. Altitude during operation relating to sea level enstallation altitude above sea level, max. configuration / header configuration / programming / header Programming language - LAD Yes - STL - SCL - GRAPH Yes Know-how protection User program protection/password protection Solocy protection Solocy protection Password for display Password for display Protection level: Write protection Protection level: Read/write protection Protection level: Read/write protection Protection level: Read/write protection Protection level: Complete protection Protection level: Complete protection Protection level: Complete protection Pess Midth Height Height Welghts	 horizontal installation, min. 	-25 °C; No condensation
vertical installation, max. 40 °C; note derating data for onboard I/O in the manual. Display: 40 °C, at an operating temperature of typically 40 °C, the display is switched off Ambient temperature during storage/transportation • min. 40 °C • max. 70 °C Altitude during operation relating to sea level • Installation altitude above sea level, max. configuration / header configuration / programming / header Programming language — LAD — FBD — Yes — STL — SCL — GRAPH Yes — SCL — GRAPH Know-how protection • User program protection/password protection • Block protection • Block protection • protection of confidential configuration data • Password for display • Protection level: Read/write protection • Protection level: Read/write protection • Protection level: Complete protection • Protection level: Depth 147 mm Depth Weights	horizontal installation, max.	60 °C; note derating data for onboard I/O in the manual. Display: 50 °C, at an operating temperature of typically 50 °C, the display is switched off
operating temperature of typically 40 °C, the display is switched off Ambient temperature during storage/transportation • min. • max. 70 °C Allitude during operation relating to sea level • Installation altitude above sea level, max. 5 000 m; Restrictions for installation altitudes > 2 000 m, see manual configuration / programming / header Programming language — LAD — FBD — Yes — STL — SCL — GRAPH — Yes Know-how protection • User program protection/password protection • User program protection/password protection • User program protection/password protection • Protection of confidential configuration data • Password for display • Protection level: Write protection • Protection level: Read/write protection • Protection level: Complete protection • Poepth • 129 mm Wolghts	 vertical installation, min. 	-25 °C; No condensation
 • min. • max. 70 °C Alittude during operation relating to sea level • Installation altitude above sea level, max. 5 000 m; Restrictions for installation altitudes > 2 000 m, see manual configuration / header configuration / programming / header Programming language — LAD — FBD — FBD — STL — SCL — GRAPH Yes Know-how protection • User program protection/password protection • User program protection/password protection • Block protection • Block protection • Protection of confidential configuration data • Protection level: Write protection • Protection level: Write protection • Protection level: Complete protection Yes • Protection level: Omplete protection Yes • Protec	vertical installation, max.	
	Ambient temperature during storage/transportation	
Altitude during operation relating to sea level Installation altitude above sea level, max. 5 000 m; Restrictions for installation altitudes > 2 000 m, see manual configuration / header configuration / programming / header Programming language	• min.	-40 °C
Installation altitude above sea level, max. Installation altitude above sea level, max. Installation altitudes > 2 000 m, see manual Installation / programming / header Installation altitudes > 2 000 m, see manual Installation altitudes	• max.	70 °C
configuration / header configuration / programming / header Programming language — LAD Yes — FBD Yes — STL Yes — SCL Yes — SCL Yes — GRAPH Yes Know-how protection • User program protection/password protection Yes • Copy protection Yes • Block protection • Protection of confidential configuration data Yes • Password for display Yes • Protection level: Write protection Yes • Protection level: Read/write protection Yes • Protection level: Complete protection Yes • Protection level: Office Protection Yes • Protection level: Office Protection Yes • Protection level: Office Protection Yes • Protection Indicate Protection Yes • Pr	Altitude during operation relating to sea level	
configuration / programming / header Programming language — LAD — FBD — FBD — STL — SCL — SCL — GRAPH — Yes Know-how protection • User program protection/password protection • User program protection/password protection • Block protection • protection of confidential configuration data • protection of confidential configuration data • Password for display • Protection level: Write protection • Protection level: Write protection • Protection level: Read/write protection • Protection level: Complete protection • Protection level: Tomplete protection • Protection level: Complete protection • Protection level: Tomplete protection • Protec	 Installation altitude above sea level, max. 	5 000 m; Restrictions for installation altitudes > 2 000 m, see manual
Programming language - LAD Yes - FBD Yes - STL Yes - SCL Yes - GRAPH Yes Know-how protection • User program protection/password protection Yes • Block protection Yes • Block protection • protection of confidential configuration data Yes • Password for display Yes • Protection level: Write protection Yes • Protection level: Write protection Yes • Protection level: Complete protection Yes Dimensions Width 85 mm Height 147 mm Depth 129 mm	configuration / header	
- LAD Yes - FBD Yes - STL Yes - SCL Yes - SCL Yes - GRAPH Yes SCL YES YES YES SCL YES	configuration / programming / header	
FBD Yes STL Yes SCL Yes GRAPH Yes Know-how protection • User program protection/password protection Yes • Copy protection Yes • Block protection Yes Access protection • protection of confidential configuration data Yes • Protection for display Yes • Protection level: Write protection Yes • Protection level: Read/write protection Yes • Protection level: Complete protection Yes • Protection level: Complete protection Yes • Protection level: Complete protection Yes • Protection level: 147 mm Depth 129 mm Weights	Programming language	
— STL — SCL — GRAPH Yes Know-how protection • User program protection/password protection • Copy protection • Block protection • protection of confidential configuration data • Password for display • Protection level: Write protection • Protection level: Read/write protection • Protection level: Complete protection • Protection level: Complete protection • Protection level: Tomplete protection • Protection level: As 5 mm Height Height 147 mm Depth Weights	— LAD	Yes
— SCL — GRAPH Yes Know-how protection • User program protection/password protection • Copy protection • Block protection • protection of confidential configuration data • Password for display • Protection level: Write protection • Protection level: Read/write protection • Protection level: Complete protection • Protection level: Complete protection • Protection level: Tomplete protection	— FBD	Yes
— GRAPH Yes Know-how protection Yes ● User program protection/password protection Yes ● Copy protection Yes ● Block protection Yes Access protection Yes ● protection of confidential configuration data Yes ● Password for display Yes ● Protection level: Write protection Yes ● Protection level: Read/write protection Yes ● Protection level: Complete protection Yes Dimensions Width 85 mm Height 147 mm Depth 129 mm Weights	— STL	Yes
Know-how protection User program protection/password protection Copy protection Block protection Yes Protection protection of confidential configuration data Password for display Protection level: Write protection Protection level: Write protection Protection level: Read/write protection Protection level: Complete protection Protection level: Complete protection Width S5 mm Height 147 mm Depth 129 mm Weights	— SCL	Yes
User program protection/password protection Copy protection Block protection Yes Access protection protection of confidential configuration data Password for display Protection level: Write protection Protection level: Read/write protection Protection level: Complete protection Protection level: Complete protection Protection level: Complete protection Protection level: Tomplete protection Protection level: Protection leve	— GRAPH	Yes
Copy protection Block protection Yes Access protection protection of confidential configuration data Password for display Protection level: Write protection Protection level: Read/write protection Protection level: Complete protection Protection level: Complete protection Protection level: Complete protection Protection level: The months of the mo	Know-how protection	
Block protection Access protection protection of confidential configuration data Password for display Protection level: Write protection Protection level: Read/write protection Protection level: Complete protection Protection level: Complete protection Protection level: Table 147 mm Depth Weights	 User program protection/password protection 	Yes
Access protection • protection of confidential configuration data • protection of confidential configuration data • Password for display • Protection level: Write protection • Protection level: Read/write protection • Protection level: Complete protection • Protection level: Complete protection Yes • Protection level: Complete protection Yes Dimensions Width 85 mm Height 147 mm Depth Depth 129 mm Weights	 Copy protection 	Yes
protection of confidential configuration data Password for display Protection level: Write protection Protection level: Read/write protection Protection level: Complete protection Protection level: Complete protection Yes Protection level: Complete protection Yes Dimensions Width 85 mm Height 147 mm Depth 129 mm Weights	Block protection	Yes
Password for display Protection level: Write protection Protection level: Read/write protection Protection level: Read/write protection Protection level: Complete protection Protection level: Area Management of the protection Protection level: Area Management of the protection Protection level: Read/write protection Protection level: Area Management of the protection	Access protection	
Protection level: Write protection Protection level: Read/write protection Protection level: Complete protection Protection level: Complete protection Yes Dimensions Width 85 mm Height 147 mm Depth 129 mm Weights	 protection of confidential configuration data 	Yes
Protection level: Read/write protection Protection level: Complete protection Yes Dimensions Width 85 mm Height 147 mm Depth 129 mm Weights	 Password for display 	Yes
● Protection level: Complete protection Dimensions Width 85 mm Height 147 mm Depth 129 mm Weights	 Protection level: Write protection 	Yes
Dimensions Width 85 mm Height 147 mm Depth 129 mm Weights ***	 Protection level: Read/write protection 	Yes
Width 85 mm Height 147 mm Depth 129 mm Weights	 Protection level: Complete protection 	Yes
Height 147 mm Depth 129 mm Weights	Dimensions	
Depth 129 mm Weights	Width	85 mm
Weights	Height	147 mm
	Depth	129 mm
Weight, approx. 1 050 g	Weights	
	Weight, approx.	1 050 g

last modified:

8/16/2023